

## N-Channel Dual Gate MOS-Fieldeffect Tetrode, Depletion Mode

Electrostatic sensitive device.  
Observe precautions for handling.

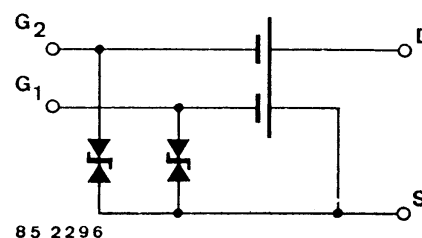
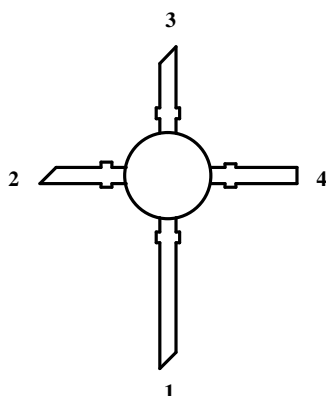


### Applications

Input and mixer stages of VHF- and UHF-tuners.

### Features

- Integrated gate protection diodes
- High cross modulation performance
- Low noise figure
- High gain
- High AGC-range
- Low feedback capacitance
- Low input capacitance



BF988 Marking: BF988

Plastic case (TO 50)

1 = Drain, 2 = Source, 3 = Gate 1, 4 = Gate 2

### Absolute Maximum Ratings

Parameters	Symbol	Value	Unit
Drain source voltage	$V_{DS}$	12	V
Drain current	$I_D$	30	mA
Gate 1/gate 2-source peak current	$\pm I_{G1/2SM}$	10	mA
Total power dissipation $T_{amb} \leq 60^\circ\text{C}$	$P_{tot}$	200	mW
Channel temperature	$T_{Ch}$	150	$^\circ\text{C}$
Storage temperature range	$T_{stg}$	-55 to +150	$^\circ\text{C}$

### Maximum Thermal Resistance

Parameters	Symbol	Value	Unit
Channel ambient on glass fibre printed board (40 x 25 x 1.5) mm <sup>3</sup> plated with 35 $\mu\text{m}$ Cu	$R_{thChA}$	450	K/W

## Electrical DC Characteristics

$T_{amb} = 25^{\circ}\text{C}$ , unless otherwise specified

Parameters / Test Conditions	Type	Symbol	Min.	Typ.	Max.	Unit
Drain-source breakdown voltage $I_D = 10 \mu\text{A}$ , $-V_{G1S} = -V_{G2S} = 4 \text{ V}$		$V_{(BR)DS}$	12			V
Gate 1-source breakdown voltage $\pm I_{G1S} = 10 \text{ mA}$ , $V_{G2S} = V_{DS} = 0$		$\pm V_{(BR)G1SS}$	8		14	V
Gate 2-source breakdown voltage $\pm I_{G2S} = 10 \text{ mA}$ , $V_{G1S} = V_{DS} = 0$		$\pm V_{(BR)G2SS}$	8		14	V
Gate 1-source leakage current $\pm V_{G1S} = 5 \text{ V}$ , $V_{G2S} = V_{DS} = 0$		$\pm I_{G1SS}$			50	nA
Gate 2-source leakage current $\pm V_{G2S} = 5 \text{ V}$ , $V_{G1S} = V_{DS} = 0$		$\pm I_{G2SS}$			50	nA
Drain current $V_{DS} = 8 \text{ V}$ , $V_{G1S} = 0$ , $V_{G2S} = 4 \text{ V}$	BF988 BF988A BF988B	$I_{DSS}$ $I_{DSS}$ $I_{DSS}$	4 4 9.5		18 10.5 18	mA mA mA
Gate 1-source cut-off voltage $V_{DS} = 8 \text{ V}$ , $V_{G2S} = 4 \text{ V}$ , $I_D = 20 \mu\text{A}$		$-V_{G1S(OFF)}$			2.5	V
Gate 2-source cut-off voltage $V_{DS} = 8 \text{ V}$ , $V_{G1S} = 0$ , $I_D = 20 \mu\text{A}$		$-V_{G2S(OFF)}$			2.0	V

## Electrical AC Characteristics

$V_{DS} = 8 \text{ V}$ ,  $I_D = 10 \text{ mA}$ ,  $V_{G2S} = 4 \text{ V}$ ,  $f = 1 \text{ MHz}$ ,  $T_{amb} = 25^{\circ}\text{C}$ , unless otherwise specified

Parameters / Test Conditions	Type	Symbol	Min.	Typ.	Max.	Unit
Forward transmittance		$ y_{21s} $	21	24		mS
Gate 1-input capacitance		$C_{issg1}$		2.1	2.5	pF
Gate 2-input capacitance $V_{G1S} = 0$ , $V_{G2S} = 4 \text{ V}$		$C_{issg2}$		1.2		pF
Feedback capacitance		$C_{rss}$		25		fF
Output capacitance		$C_{oss}$		1.05		pF
Power gain $V_{DS} = 8 \text{ V}$ , $I_D = 10 \text{ mA}$ , $V_{G2S} = 4 \text{ V}$ , $g_s = 2 \text{ mS}$ , $g_L = 0.5 \text{ mS}$ , $f = 200 \text{ MHz}$ $g_s = 3.3 \text{ mS}$ , $g_L = 1 \text{ mS}$ , $f = 800 \text{ MHz}$		$G_{ps}$ $G_{ps}$	16.5	28 20		dB dB
AGC range $V_{DS} = 8 \text{ V}$ , $V_{G2S} = 4 \text{ to } -2 \text{ V}$ , $f = 800 \text{ MHz}$		$\Delta G_{ps}$	40			dB
Noise figure $V_{DS} = 8 \text{ V}$ , $I_D = 10 \text{ mA}$ , $V_{G2S} = 4 \text{ V}$ , $g_s = 2 \text{ mS}$ , $f = 200 \text{ MHz}$ $g_s = 3.3 \text{ mS}$ , $f = 800 \text{ MHz}$		F F		1 1.5		dB dB

## Common Source S-Parameters

$$V_{G2S} = 4 \text{ V}, Z_0 = 50 \ \Omega$$

V <sub>DS</sub> /V	I <sub>D</sub> /mA	f/MHz	S <sub>11</sub>		S <sub>21</sub>		S <sub>12</sub>		S <sub>22</sub>	
			LOG MAG	ANG	LOG MAG	ANG	LOG MAG	ANG	LOG MAG	ANG
			dB	deg	dB	deg	dB	deg	dB	deg
8	5	100	-0.02	-7.8	6.01	168.4	-56.27	83.0	-0.02	-3.6
		200	-0.10	-15.3	5.87	156.3	-50.61	76.6	-0.06	-7.3
		300	-0.31	-22.8	5.69	144.2	-47.70	70.9	-0.13	-10.6
		400	-0.56	-30.2	5.42	132.9	-46.19	65.6	-0.20	-14.2
		500	-0.87	-37.3	5.17	121.5	-45.46	60.6	-0.28	-17.5
		600	-1.26	-44.3	4.85	110.6	-45.84	55.4	-0.36	-20.5
		700	-1.59	-50.9	4.54	100.4	-47.31	58.6	-0.43	-23.8
		800	-2.04	-58.0	4.25	90.2	-48.19	63.3	-0.49	-26.8
		900	-2.42	-64.4	4.02	80.6	-50.37	81.5	-0.52	-30.2
		1000	-2.88	-71.4	3.78	70.8	-49.48	115.6	-0.54	-33.4
		1100	-3.39	-78.3	3.42	60.5	-47.92	131.7	-0.66	-36.8
		1200	-3.94	-85.2	3.21	51.6	-44.65	153.0	-0.66	-40.1
		1300	-4.46	-91.8	3.01	42.0	-41.76	159.8	-0.66	-43.9
	10	100	-0.02	-8.3	7.84	168.5	-55.67	83.0	-0.04	-3.7
		200	-0.11	-16.1	7.70	156.6	-50.01	76.4	-0.09	-7.4
		300	-0.35	-24.0	7.49	144.8	-47.20	70.3	-0.16	-10.8
		400	-0.62	-31.6	7.21	133.6	-45.60	65.1	-0.23	-14.3
		500	-0.97	-39.2	6.93	122.5	-44.88	60.0	-0.31	-17.9
		600	-1.39	-46.4	6.59	111.9	-45.25	54.5	-0.42	-20.9
		700	-1.76	-53.2	6.27	101.9	-46.51	57.4	-0.48	-24.1
		800	-2.25	-60.3	5.97	92.1	-47.19	61.4	-0.55	-27.3
		900	-2.67	-67.1	5.71	82.8	-49.28	76.0	-0.58	-30.6
		1000	-3.16	-74.1	5.46	73.3	-48.99	107.1	-0.60	-33.8
		1100	-3.72	-81.1	5.07	63.3	-48.03	123.3	-0.73	-37.2
		1200	-4.30	-88.0	4.85	54.6	-45.15	147.6	-0.73	-40.6
		1300	-4.87	-94.4	4.63	45.4	-42.46	157.0	-0.73	-44.3
	15	100	-0.01	-8.4	8.62	168.6	-55.26	83.0	-0.07	-3.7
		200	-0.13	-16.4	8.46	156.8	-49.61	76.3	-0.12	-7.5
		300	-0.37	-24.5	8.26	145.2	-46.70	70.3	-0.20	-11.0
		400	-0.66	-32.3	7.96	134.0	-45.10	64.9	-0.27	-14.4
		500	-1.02	-39.8	7.66	122.9	-44.38	59.7	-0.36	-18.0
		600	-1.47	-47.0	7.33	112.3	-44.65	54.3	-0.47	-20.9
		700	-1.85	-54.1	6.98	102.6	-45.72	57.0	-0.53	-24.2
		800	-2.36	-61.3	6.68	92.8	-46.29	60.0	-0.61	-27.4
		900	-2.80	-67.9	6.42	83.7	-48.18	71.9	-0.64	-30.6
		1000	-3.30	-75.0	6.15	74.3	-48.49	98.7	-0.66	-33.9
1100		-3.89	-82.0	5.75	64.6	-47.93	114.8	-0.77	-37.3	
1200		-4.49	-88.8	5.52	56.0	-45.75	141.2	-0.79	-40.8	
1300		-5.06	-95.2	5.30	46.9	-43.05	153.4	-0.79	-44.5	

## Typical Characteristics ( $T_j = 25^\circ\text{C}$ unless otherwise specified)

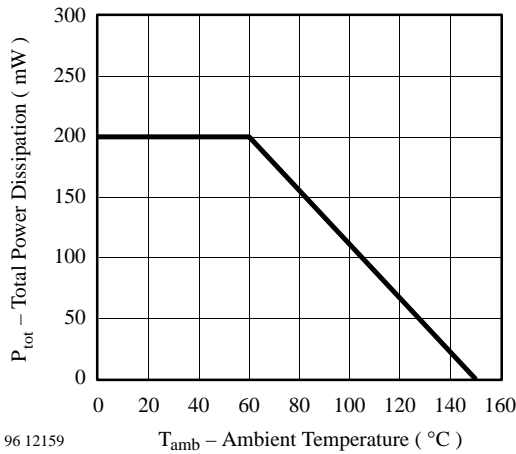


Figure 1. Total Power Dissipation vs. Ambient Temperature

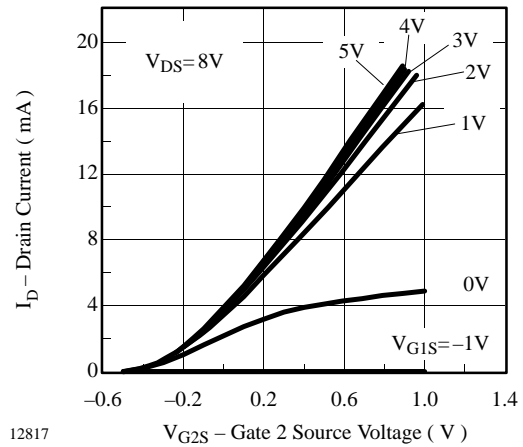


Figure 4. Drain Current vs. Gate 2 Source Voltage

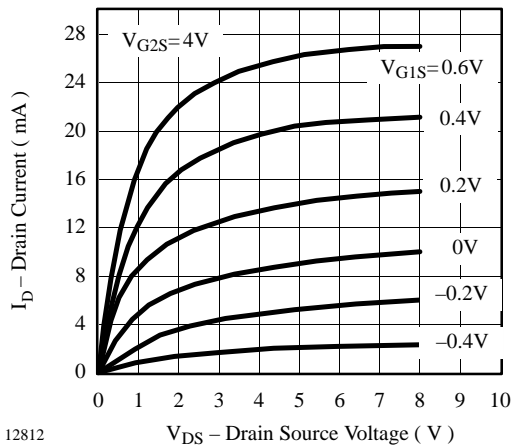


Figure 2. Drain Current vs. Drain Source Voltage

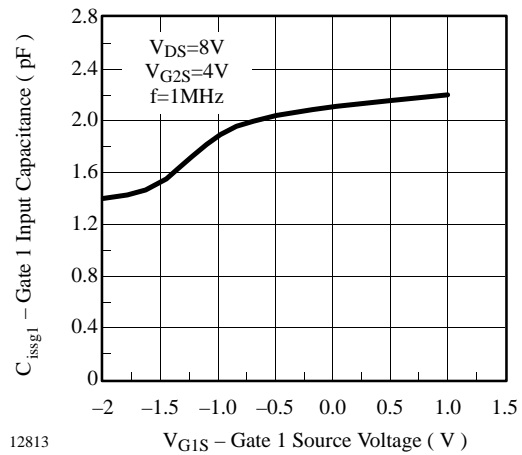


Figure 5. Gate 1 Input Capacitance vs. Gate 1 Source Voltage

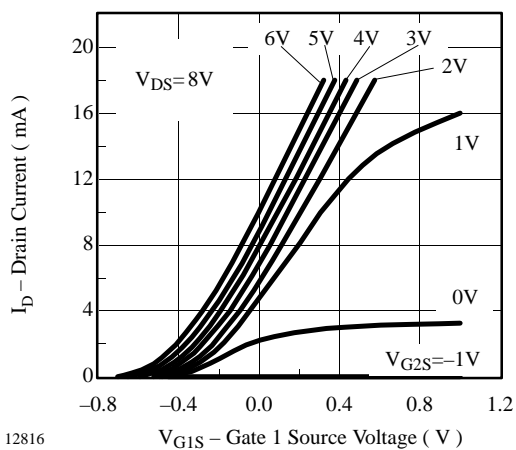


Figure 3. Drain Current vs. Gate 1 Source Voltage

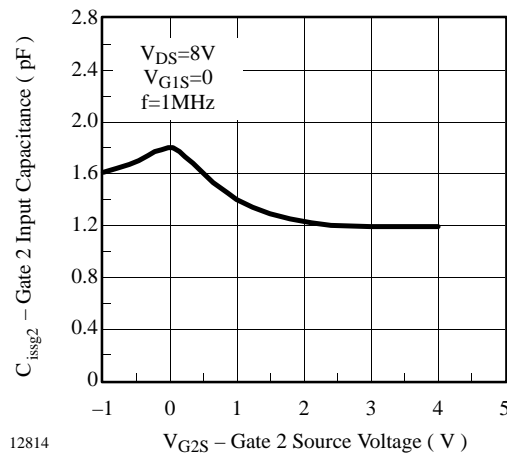


Figure 6. Gate 2 Input Capacitance vs. Gate 2 Source Voltage

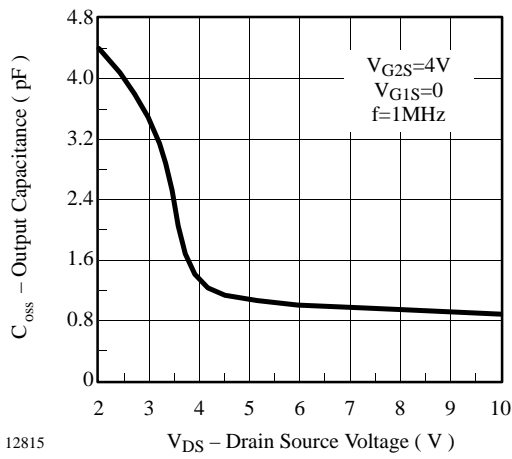


Figure 7. Output Capacitance vs. Drain Source Voltage

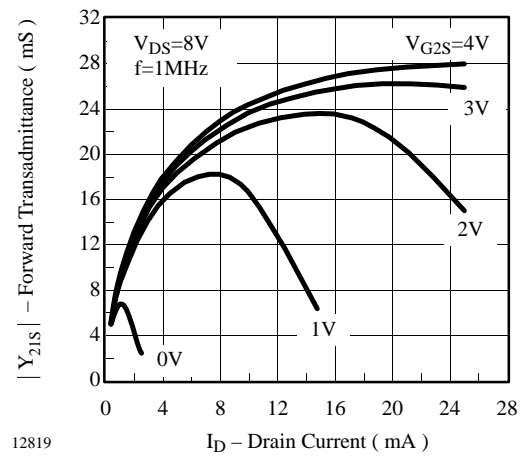


Figure 9. Forward Transadmittance vs. Drain Current

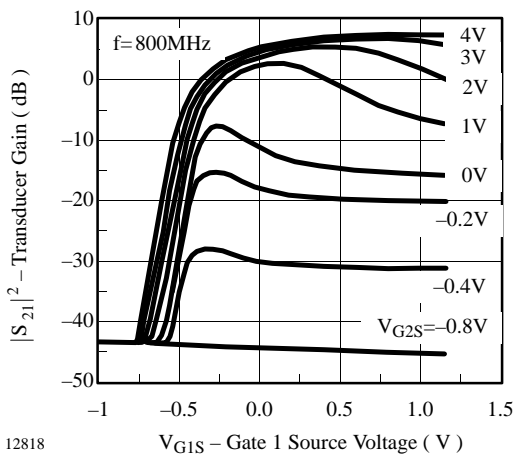
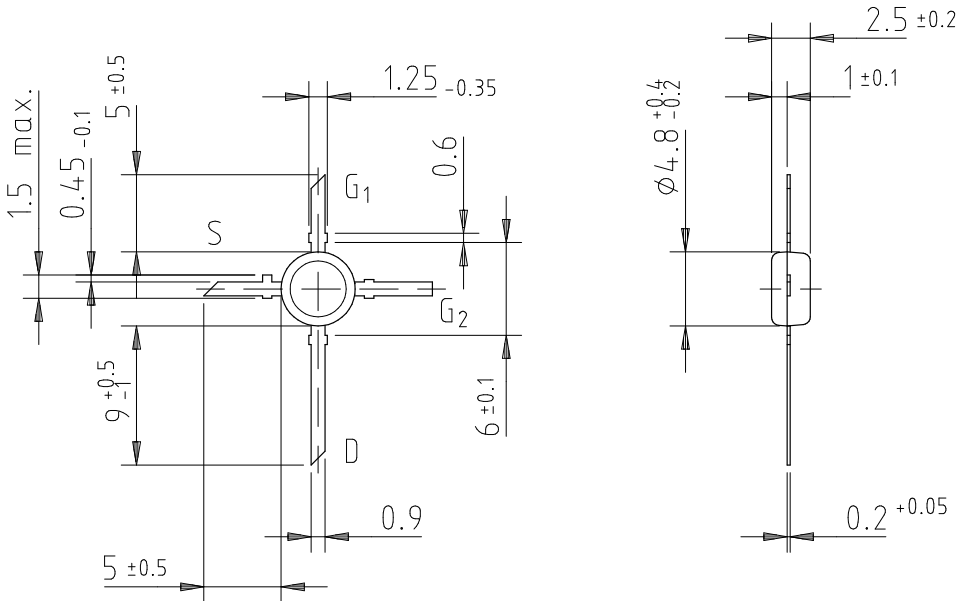
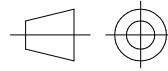


Figure 8. Transducer Gain vs. Gate 1 Source Voltage

## Dimensions in mm



96 12242



technical drawings  
according to DIN  
specifications

## Ozone Depleting Substances Policy Statement

It is the policy of **TEMIC TELEFUNKEN microelectronic GmbH** to

1. Meet all present and future national and international statutory requirements.
2. Regularly and continuously improve the performance of our products, processes, distribution and operating systems with respect to their impact on the health and safety of our employees and the public, as well as their impact on the environment.

It is particular concern to control or eliminate releases of those substances into the atmosphere which are known as ozone depleting substances (ODSs).

The Montreal Protocol (1987) and its London Amendments (1990) intend to severely restrict the use of ODSs and forbid their use within the next ten years. Various national and international initiatives are pressing for an earlier ban on these substances.

**TEMIC TELEFUNKEN microelectronic GmbH** semiconductor division has been able to use its policy of continuous improvements to eliminate the use of ODSs listed in the following documents.

1. Annex A, B and list of transitional substances of the Montreal Protocol and the London Amendments respectively
2. Class I and II ozone depleting substances in the Clean Air Act Amendments of 1990 by the Environmental Protection Agency (EPA) in the USA
3. Council Decision 88/540/EEC and 91/690/EEC Annex A, B and C (transitional substances) respectively.

**TEMIC** can certify that our semiconductors are not manufactured with ozone depleting substances and do not contain such substances.

**We reserve the right to make changes to improve technical design and may do so without further notice.**

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